



Product Change Notification / SYST-29COSO613

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Product Category:

8-bit Microcontrollers

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Document Change

Notification Subject:

ERRATA - PIC18(L)F67K40 Family Silicon Errata and Data Sheet Clarification

Affected CPNs:

[SYST-29COSO613_Affected_CPN_03312021.pdf](#)

[SYST-29COSO613_Affected_CPN_03312021.csv](#)

Notification Text:

SYST-29COSO613

Microchip has released a new Product Documents for the PIC18(L)F67K40 Family Silicon Errata and Data Sheet Clarification of devices. If you are using one of these devices please read the document located at [PIC18\(L\)F67K40 Family Silicon Errata and Data Sheet Clarification](#).

Notification Status: Final

Description of Change:

This revision includes the following updates to Data Sheet Clarifications:

- 1) Added silicon revisions 2.1.4, 2.1.5, 2.5.2, 2.6.3, 2.8.1 and 2.9.1.
- 2) Data Sheet Clarifications: Added Module 3.2 (Pin Diagrams), Module 3.2 (Electrical Specifications), Module 3.3 (Analog-to-Digital Converter) and Module 3.4 (Capture/Compare/PWM (CCP) Module).

Impacts to Data Sheet: None

Reason for Change: To Improve Productivity

Change Implementation Status: Complete

Date Document Changes Effective: 31 Mar 2021

NOTE: Please be advised that this is a change to the document only the product has not been changed.

Markings to Distinguish Revised from Unrevised Devices: N/A

Attachments:

[PIC18\(L\)F67K40 Family Silicon Errata and Data Sheet Clarification](#)

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Affected Catalog Part Numbers (CPN)

PIC18F67K40-E/MR

PIC18F67K40-E/PT

PIC18F67K40-I/MR

PIC18F67K40-I/PT

PIC18F67K40T-I/MR

PIC18F67K40T-I/PT

PIC18LF67K40-E/MR

PIC18LF67K40-E/PT

PIC18LF67K40-I/MR

PIC18LF67K40-I/PT

PIC18LF67K40T-I/MR

PIC18LF67K40T-I/PT



PIC18(L)F67K40

PIC18(L)F67K40 Family Silicon Errata and Data Sheet Clarification

The PIC18(L)F67K40 devices that you have received conform functionally to the current device data sheet (DS40001841D), except for the anomalies described in this document.

The silicon issues discussed in the following pages are for silicon revisions with the Device and Revision IDs listed in the table below.

The errata described in this document will be addressed in future revisions of the PIC18(L)F67K40 silicon.

Note: This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current.

Table 1. Silicon Device Identification

Part Number	Device ID	Revision ID	
		A2	A3
PIC18F67K40	0x6AC0	0xA002	0xA003
PIC18LF67K40	0x6B20	0xA002	0xA003

1. Silicon Issue Summary

Table 1-1. Silicon Issue Summary

Module	Feature	Item No.	Issue Summary	Affected Revisions	
				A2	A3
Analog-to-Digital Converter (ADC)	ADC Conversion	2.1.1	Delay of one instruction cycle required prior to setting the ADGO bit when using ADCRC as the ADCC clock source.	X	
Analog-to-Digital Converter (ADC)	ADCR Oscillator Operation in Sleep	2.1.2	The ADCRC oscillator does not stop after conversion is complete in Sleep mode.	X	X
Analog-to-Digital Converter (ADC)	ADC Conversion with FVR	2.1.3	Using FVR as the ADC positive voltage reference can cause missing codes.	X	X
Analog-to-Digital Converter (ADC)	ADC conversion with F _{OSC} as clock	2.1.4	The ADGO bit remains set when using F _{OSC} as clock source with clock divider.	X	X
Analog-to-Digital Converter (ADC)	ADC operation in Burst Average mode	2.1.5	The ADCNT register does not increment past '0b1' in Burst Average mode with double sampling enabled.	X	X
PIC18 Debug Executive	Data Write Match Breakpoints	2.2.1	Data write match breakpoints do not work when used on a location GSR space.	X	
PIC18 Core	TBLRD	2.3.1	TBLRD requires NVMREG value to point to appropriate memory.	X	
Program Flash Memory (PFM)	Endurance of PFM Cell	2.4.1	Endurance of the PFM cell is lower than specified.	X	X
MSSP	SMBus 2.0 Voltage Level	2.5.1	Input low-voltage threshold level is dependent on V _{DD} .	X	X
MSSP	SPI	2.5.2	SSPBUF may become corrupted	X	X
Electrical Specifications	Min V _{DD} Specification	2.6.1	V _{DDMIN} specifications are changed for LF devices only for -40°C and 0°C.		X
Electrical Specifications	FVR Specification	2.6.2	FVR specifications require use above -20°C.	X	X
Electrical Specifications	Analog to Digital Converter	2.6.3	ADC offset error specification is +/- 3.0 LSb.	X	X
Timer0	Clock Source	2.7.1	Operation of Timer0 is incorrect when F _{OSC} /4 is used as the clock source.	X	X
Windowed Watchdog Timer	WWDT operation in Doze mode	2.8.1	Erroneous window violation error occurs in Doze mode.	X	X
NVM	NVMERR bit operation	2.9.1	NVMERR bit is set incorrectly due to specific Reset events.	X	X

Note: Only those issues indicated in the last column apply to the current silicon revision.

2. Silicon Errata Issues



Notice: This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current. Only the issues indicated by the bold font in the following tables apply to the current silicon revision.

2.1 Module: ADCC - Analog-to-Digital Converter with Computation

2.1.1 ADC Conversion

When using the ADCRC as the clock source for ADCC, there is a delay of one instruction cycle between the user setting the ADGO bit and being able to read it set. This can lead to a false conversion complete scenario (i.e., ADGO being cleared), depending if the user code has a bit clear test `BTFSC` instruction on the ADGO bit, immediately after setting the ADGO bit. See code example below.

```
BSF ADCON0, ADGO           ; Start conversion
BTFSC ADCON0, ADGO        ; Is conversion done?
GOTO $-1                   ; No, test again
```

Work around

Add a `NOP` instruction after setting the ADGO bit and before testing the bit for completion of conversion. See code example below.

```
BSF ADCON0, ADGO           ; Start conversion
NOP
BTFSC ADCON0, ADGO        ; Is conversion done?
GOTO $-1                   ; No, test again
```

Affected Silicon Revisions

A2	A3						
X							

2.1.2 ADCRC Oscillator Operation in Sleep

If the part is in Sleep and the ADCRC oscillator is used as clock source to the ADC, the oscillator continues to run after the conversion is complete. This will increase the current consumption in Sleep mode. The oscillator will stop after the device exits Sleep mode and resumes normal code execution.

Work around

None.

Affected Silicon Revisions

A2	A3						
X	X						

2.1.3 Missing Codes with FVR Reference

Using the FVR as the positive voltage reference for the ADC can cause an increase in missing codes.

Work around

Method 1:

Increase the bit conversion time, known as T_{AD} , to 8 μ s or higher.

Method 2:

Use V_{DD} as the positive voltage reference to the ADC.

Affected Silicon Revisions

A2	A3						
X	X						

2.1.4 ADC GO Bit May Remain Set When the Clock Source is F_{OSC}

When using F_{OSC} as the clock source ($ADCON0.CS = 0$) and any clock divider setting other than $F_{OSC}/2$ is selected, the ADGO bit remains set and the conversion does not complete.

Work around

Method 1:

When using F_{OSC} as the clock source ($ADCON0.CS = 0$), clear the ADCLK register value to zero ($ADCLK.CS = 0$) and ensure that the F_{OSC} frequency does not violate any timing requirements for the ADC.

Method 2:

Use ADCRC as the clock source ($ADCON0.CS = 1$).

Affected Silicon Revisions

A2	A3						
X	X						

2.1.5 ADCC Burst Average Mode

When the ADCC is operated in Burst Average mode ($ADMD = 0b011$ in the $ADCON2$ register) while enabling noncontinuous operation and double-sampling ($ADCONT = 0$ in the $ADCON0$ register and $ADDSSEN = 1$ in the $ADCON1$ register), the value in the $ADCNT$ register does not increment beyond '0b1' toward the value in the $ADRPT$ register.

Work around

When operating the ADCC in Burst Average mode with double-sampling, enable continuous operation of the module ($ADCONT = 1$ in the $ADCON0$ register) and set the Stop-on-Interrupt bit (the $ADSOI$ bit in the $ADCON3$ register). After the interrupt occurs, perform appropriate threshold calculations in the software and retrigger ADCC as necessary.

Alternatively, if the CPU is in Low-Power Sleep mode, the ADCC in noncontinuous Burst Average mode can be operated with a single ADC conversion ($ADDSSEN = 0$ in the $ADCON1$ register). Doing so compromises noise immunity for lower power consumption by preventing the device from waking up to perform threshold calculations in the software.

Affected Silicon Revisions

A2	A3						
X	X						

2.2 Module: PIC18 Debug Executive

2.2.1 Data Write Match Breakpoints

If the data in a GPR location is modified using any arithmetic instruction like `INCF`, `ADDWF`, `SETF`, `CLRF`, etc., the data write match breakpoint does not work. It works with `MOVF`, which moves the data into the same memory location. See code examples below.

1.

```
MOVLB    0x00
CLRF     0x08
LOOP
INCF     0x08    ;Doesn't break when data
                breakpoint set @ 0x08
                with data match for 0xAA
GOTO LOOP
```

2.

```
MOVLB    0x00
MOVLW    0xAA
MOVF     0x08    ;Breaks when data
                breakpoint set @ 0x08
                with data match for 0xAA
GOTO LOOP
```

Work around

Use data write breakpoints without matching wherever possible.

Affected Silicon Revisions

A2	A3						
X							

2.3 Module: PIC18 Core

2.3.1 TBLRD Requires NVMREG Value to Point to Appropriate Memory

The affected silicon revisions of the PIC18(L)F67K40 devices improperly require the `NVMREG[1:0]` bits in the `NVMCON` register to be set for `TBLRD` access of the various memory regions. The issue is most apparent in compiled C programs when the user defines a const type and the compiler uses `TBLRD` instructions to retrieve the data from Program Flash Memory (PFM). The issue is also apparent when the user defines an array in RAM for which the compiler creates start-up code, executed before `main()`, that uses `TBLRD` instructions to initialize RAM from PFM.

Work around

Assembly code:

Set the `NVMREG[1:0]` bits to select the appropriate memory region before executing `TBLRD` instructions.

C code:

Create an assembly file named `powerup.as` and include this file with the other files in the project. This file will change the `NVMREG[1:0]` bits to point to program Flash before any code is executed. Contents of the `powerup.as` file:

```
#include <xc.inc>
GLOBAL    powerup, start
PSECT     powerup, class=CODE, delta=1, reloc=2
powerup:
```



```

BSF      NVMCON1, 7
GOTO    start
end

```

If there is a need to change the NVMREG[1:0] value to anything other than '10' and the Interrupt Service Routine uses constants or literal strings, then interrupts must be disabled before the change and restored to '10' before interrupts are enabled.

Affected Silicon Revisions

A2	A3						
X							

2.4 Module: PFM - Program Flash Memory

2.4.1 Endurance of PFM is Lower than Specified

The Flash memory cell endurance specification (Parameter MEM30) is 1K cycles.

Work around

None.

Affected Silicon Revisions

A2	A3						
X	X						

2.5 Module: MSSP

2.5.1 SMBus 2.0 Voltage Level

The input low-voltage threshold level (V_{IL}) depends on V_{DD} , as follows:

$V_{IL} = 0.7$ for $V_{DD} < 4V$

$V_{IL} = 0.8$ for $V_{DD} > 4V$

Work around

None.

Affected Silicon Revisions

A2	A3						
X	X						

2.5.2 MSSP SPI Client Mode

When operating in SPI Client mode, if the incoming SCK clock signal arrives during any of the conditions below, the SSPBUF Transmit Shift Register (TSR) may become corrupted. The byte transmitted to the client cannot be ensured to be correct, and the state of the WCOL bit may or may not indicate a write collision.

These conditions include:

- A write to an SFR
- A write to RAM following an SFR read
- A write to RAM prior to an SFR read

Work around

Method 1 (Interrupt based using \overline{SS}):

1. Connect the \overline{SS} line to both the \overline{SS} input and either an INT or IOC input pin.
2. Enable INT or IOC interrupts (interrupt on falling edge if available, otherwise check that $\overline{SS} == 0$ when the interrupt occurs).
3. Load SSPBUF with the data to be transmitted.
4. Continue program execution.
5. When the Interrupt Service Routine (ISR) is invoked, do either of the following:
 - 5.1. Add a delay that ensures the first SCK clock will be complete, or
 - 5.2. Poll SSPSTAT.BF (while(BF == 0)), and wait for the transmission/reception to complete.

Method 2 (Bit polling based using \overline{SS}):

1. Load SSPBUF with the data to be transmitted.
2. Poll the \overline{SS} line and wait for the \overline{SS} to go active (while(!PORTx. $\overline{SS} == 0$)).
3. When \overline{SS} is active ($\overline{SS} == 0$), do either of the following:
 - 3.1. Add a delay that ensures the first SCK clock will be complete, or
 - 3.2. Poll SSPSTAT.BF (while(BF == 0)), and wait for the transmission/reception to complete.

Once one of these two methods are complete, it is safe to return to program execution.

Method 3 (\overline{SS} not available):

1. Load SSPBUF with the data to be transmitted.
2. Poll SSPSTAT.BF (while(BF == 0)), and wait for the transmission/reception to complete.

Affected Silicon Revisions

A2	A3						
X	X						

2.6 Module: Electrical Specifications

2.6.1 Min V_{DD} Specification (LF Devies Only)

V_{DDMIN} specifications are changed for LF devices only at -40°C and 0°C as below.

V_{DDMIN} for -40°C to 0°C = 2.3V

V_{DDMIN} for 0°C to 25°C = 2.1V

Work around

None.

Affected Silicon Revisions

A2	A3						
	X						

2.6.2 FVR - Fixed Voltage Reference

At temperatures below -20°C, the output voltage for the FVR may be greater than the levels specified in the data sheet. This will apply to all three gain amplifier settings, (1X, 2X, 4X). The affected parameter numbers found in the data sheet are: FVR01 (1X gain setting), FVR02 (2X gain setting), and FVR03 (4X gain setting).

Work around

At temperatures above -20°C, the stated tolerances in the data sheet remain in effect. Operate the FVR only at temperatures above -20°C.

Affected Silicon Revisions

A2	A3						
X	X						

2.6.3 ADC - Analog to Digital Converter

The table containing the Offset Error specification (AD04: EOFF) for the Analog-to-Digital Converter is modified. The updated value for Offset Error specification is +/- 3.0 LSB.

Work around

None.

Affected Silicon Revisions

A2	A3						
X	X						

2.7 Module: Timer0

2.7.1 Clock Source

Clearing the T0ASYNC bit in the T0CON1 register when Timer0 is configured to use $F_{OSC}/4$ may cause incorrect behavior. This issue is only valid when $F_{OSC}/4$ is used as the clock source.

Work around

Set the T0ASYNC bit in the T0CON1 register when using $F_{OSC}/4$ as the Timer0 clock.

Affected Silicon Revisions

A2	A3						
X	X						

2.8 Module: Windowed Watchdog Timer (WWDT)

2.8.1 Window Operation in Doze Mode

When the Windowed mode of operation is enabled in Doze mode, a window violation error is issued even though the window is open and has been armed. This condition occurs only when the window size is set to a value other than 100% open.

Work around

Method 1:

Use the Windowed mode of operation in any mode other than Doze. If disabling the Doze mode is not an option, use the WWDT module without the window being enabled.

Method 2:

If the device is in Doze mode, perform the arming process for the window in Normal mode and return to the Doze mode.

Method 3:

If there is an Interrupt Service Routine (ISR) in the application code, the arming within the window can be done inside the ISR with the ROI bit of the CPUDOZE register being set.

Affected Silicon Revisions

A2	A3						
X	X						

2.9 Module: Nonvolatile Memory (NVM)

2.9.1 NVMERR

When a Reset is issued while an NVM high-voltage operation is in progress, the NVMERR bit in the NVMCON0 register is set as expected. After clearing the NVMERR bit, if a Reset reoccurs, the NVMERR bit is set again regardless of whether an NVM operation is in progress or not. A successful write operation will clear the NVMERR condition.

Work around

None.

Affected Silicon Revisions

A2	A3						
X	X						

3. Data Sheet Clarifications

The following typographic corrections and clarifications are to be noted for the latest version of the device data sheet (DS40001841D):

Note:

Corrections are shown in **bold**. Where possible, the original bold text formatting has been removed for clarity.

3.1 Module: Core Features

3.1.1 Operating Speed

The bullet point mentioning the operating speed on page 1 is incorrect. The correct text is shown below.

- Operating Speed
 - **DC-64 MHz clock input**
 - 62.5 ns minimum instruction cycle

3.2 Module: Electrical Specifications

3.2.1 ADC Offset Error

Table 38-13 containing the Offset Error Specification (AD04 : E_{OFF}) for the Analog-to-Digital Converter is modified.

The updated value for Offset Error Specification (**AD04**) is **±2.5 LSB**.

3.2.2 ADC Conversion Timing Diagram

Refer to the images below for corrections of Figure 38-10 and Figure 38-11. Previously, the parameter numbers were incorrect.

Figure 38-10: ADC Conversion Timing (ADC Clock F_{OSC}-Based)

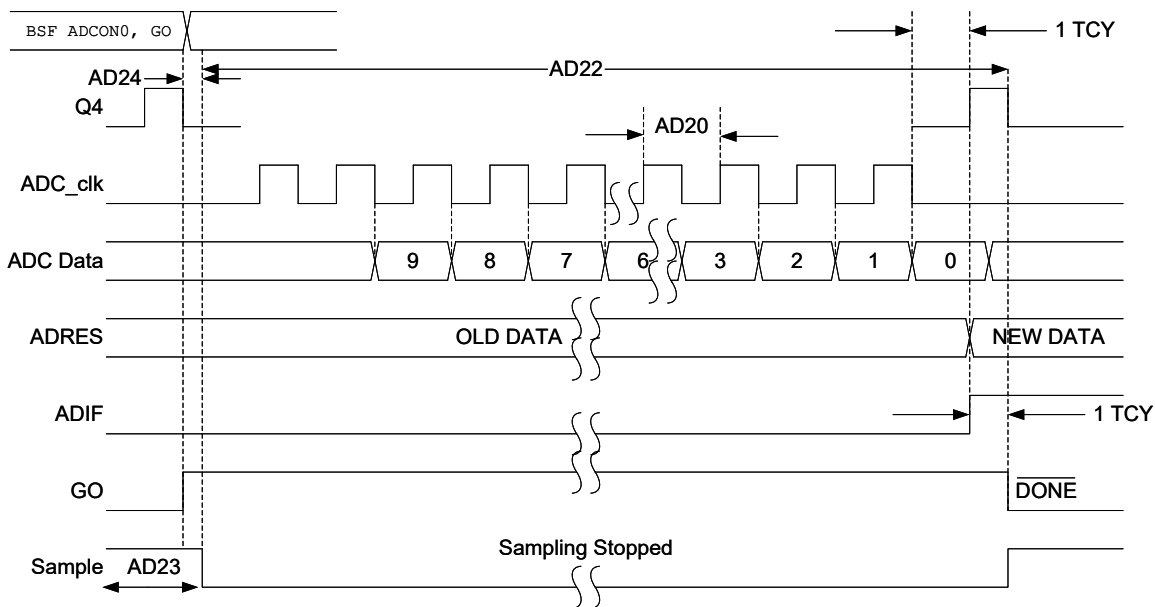
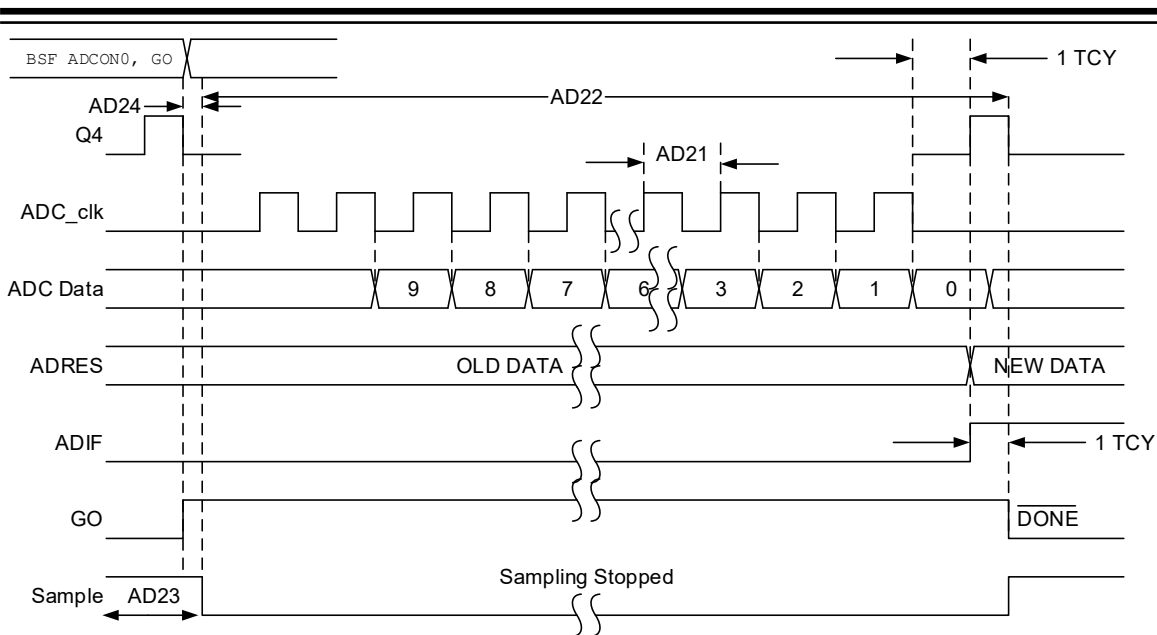


Figure 38-11: ADC Conversion Timing (ADC Clock from ADCRC)



3.2.3 Comparator Offset Error

Table 38-15 containing the Input Offset Voltage Error Specification (CM01 : V_{IOFF}) for the Comparator is modified. The updated value for Input Offset Voltage Specification (**CM01**) is $\pm 60\text{mV}$.

3.2.4 I/O Ports - I²C Threshold Values

Table 38-4 containing the Input Low Voltage with I²C levels specification (D303 : V_{IL}) for the I/O ports is modified. Refer to the table below for the updated value.

Param No.	Sym.	Characteristic	Min.	Typ.†	Max.	Units	Conditions
D303	V _{IL}	Input Low Voltage					
		I/O PORT:					
		with I ² C levels	–	–	0.3 V _{DD}	V	2.0V ≤ V _{DD} ≤ 5.5V
			–	–	0.25 V _{DD}	V	1.8V ≤ V _{DD} < 2.0V

3.3 Module: Analog-to-Digital Converter

3.3.1 ADC Clock Period vs Device Frequency

The ADCLK value for F_{OSC}/16 in Table 31-2 is incorrect. The correct value can be found in the table below.

ADC Clock Period (T _{AD})		Device Frequency (F _{OSC})						
ADC Clock Source	ADCLK	64 MHz	32 MHz	20 MHz	16 MHz	8 MHz	4 MHz	1 MHz
F _{OSC} /2	000000	31.25 ns ⁽²⁾	62.5 ns ⁽²⁾	100 ns ⁽²⁾	125 ns ⁽²⁾	250 ns ⁽²⁾	500 ns ⁽²⁾	2.0 μs
F _{OSC} /4	000001	62.5 ns ⁽²⁾	125 ns ⁽²⁾	200 ns ⁽²⁾	250 ns ⁽²⁾	500 ns ⁽²⁾	1.0 μs	4.0 μs
F _{OSC} /6	000010	125 ns ⁽²⁾	187.5 ns ⁽²⁾	300 ns ⁽²⁾	375 ns ⁽²⁾	750 ns ⁽²⁾	1.5 μs	6.0 μs
F _{OSC} /8	000011	187.5 ns ⁽²⁾	250 ns ⁽²⁾	400 ns ⁽²⁾	500 ns ⁽²⁾	1.0 μs	2.0 μs	8.0 μs ⁽³⁾
...
F _{OSC} /16	000111	250 ns ⁽²⁾	500 ns ⁽²⁾	800 ns ⁽²⁾	1.0 μs	2.0 μs	4.0 μs	16.0 μs ⁽³⁾
...
F _{OSC} /128	111111	2.0 μs	4.0 μs	6.4 μs	8.0 μs	16.0 μs ⁽³⁾	32.0 μs ⁽²⁾	128.0 μs ⁽²⁾
FRC	ADCS=1	1.0-6.0 μs	1.0-6.0 μs	1.0-6.0 μs	1.0-6.0 μs	1.0-6.0 μs	1.0-6.0 μs	1.0-6.0 μs

Note:

1. See T_{AD} parameter in the "Electrical Specifications" section for FRC source typical T_{AD} value.
2. These values violate the required T_{AD} time.
3. Outside the recommended T_{AD} time.
4. The ADC clock period (T_{AD}) and total ADC conversion time can be minimized when the ADC clock is derived from the system clock F_{OSC}. However, the FRC oscillator source must be used when conversions are to be performed with the device in Sleep mode.

3.3.2 ADCRS Bits Description in the ADCON2 Register

The description for the ADCRS[2:0] bits in the ADCON2 register is incorrect. The correct description is mentioned below.

3.3.2.1 ADCON2

Name: ADCON2

Bits 6:4 – ADCRS[2:0] ADC Accumulated Calculation Right Shift Select bits

Value	Condition	Description
1 to 6	ADMD = 'b100	Low-pass filter time constant is 2^{ADCRS} , filter gain is 1:1 ⁽²⁾
1 to 6	ADMD = 'b011 to 'b001	The accumulated value is right-shifted by ADCRS (divided by 2^{ADCRS}) ^(1,2)
x	ADMD = 'b000	These bits are ignored

3.3.3 ADC Precharge Time Control Register

Refer to the register below for the modified description of the ADPRE register.

3.3.3.1 ADPRE

Name: ADPRE
Offset: 0xF5E

ADC Precharge Time Control Register

	7	6	5	4	3	2	1	0
	ADPRE[7:0]							
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bits 7:0 – ADPRE[7:0] Precharge Time Select bits

Table 3-1.

ADPRE	Precharge Time	
	ADCS != F _{RC}	ADCS = F _{RC}
255	255 clock of F _{OSC}	255 clock of F _{RC}
254	254 clock of F _{OSC}	254 clock of F _{RC}
...	...	
2	2 clock of F _{OSC}	2 clock of F _{RC}
1	1 clock of F _{OSC}	1 clock of F _{RC}
0	Not included in the data conversion cycle	

3.3.4 ADC Acquisition Time Control Register

Refer to the register below for the modified description of the ADACQ register.

3.3.4.1 ADACQ

Name: ADACQ
Offset: 0xF5C

ADC Acquisition Time Control Register

	Bit	7	6	5	4	3	2	1	0
		ADACQ[7:0]							
Access		R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset		0	0	0	0	0	0	0	0

Bits 7:0 – ADACQ[7:0] Acquisition (charge share time) Select bits

Table 3-2.

ADACQ	Acquisition Time	
	ADCS != F _{RC}	ADCS = F _{RC}
255	255 clock of F _{OSC}	255 clock of F _{RC}
254	254 clock of F _{OSC}	254 clock of F _{RC}
...	...	
2	2 clock of F _{OSC}	2 clock of F _{RC}
1	1 clock of F _{OSC}	1 clock of F _{RC}
0	Not included in the data conversion cycle ⁽¹⁾	

Note:

- If ADPRE is not equal to '0', then ADACQ = 0b0000_0000 means Acquisition Time is 256 clocks of F_{OSC} or F_{RC}.

3.4 Module: CCP - Capture/Compare/PWM Module

3.4.1 Module Registers

The description for the CCPTMRS0 and CCPTMRS1 registers is missing in the data sheet. The description for this register is mentioned below.

Each CCP/PWM module has an independent timer selection that can be accessed using the CxTSEL or PxTSEL bits. The default timer selection is TMR1 when using Capture/Compare mode and TMR2 when using PWM mode in the CCPx module. The default timer selection for the PWM module is always TMR2.

3.4.1.1 CCPTMRS1

Name: CCPTMRS1

CCP Timers Selection Register1

	7	6	5	4	3	2	1	0
			P7TSEL[1:0]		P6TSEL[1:0]		C5TSEL[1:0]	
Access			R/W	R/W	R/W	R/W	R/W	R/W
Reset			0	1	0	1	0	1

Bits 2:3, 4:5 – PnTSEL PWMn Timer Selection bits

Value	Description
11	PWMn based on Timer8
10	PWMn based on Timer6
01	PWMn based on Timer4
00	PWMn based on Timer2

Bits 0:1 – CnTSEL[1:0] CCPn Timer Selection bits

Value	Description
11	CCPn is based off Timer7 in Capture/Compare mode and Timer8 in PWM mode
10	CCPn is based off Timer5 in Capture/Compare mode and Timer6 in PWM mode
01	CCPn is based off Timer3 in Capture/Compare mode and Timer4 in PWM mode
00	CCPn is based off Timer1 in Capture/Compare mode and Timer2 in PWM mode

3.4.1.2 CCPTMRS0

Name: CCPTMRS0

CCP Timers Selection Register0

	7	6	5	4	3	2	1	0
	C4TSEL[1:0]		C3TSEL[1:0]		C2TSEL[1:0]		C1TSEL[1:0]	
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	1	0	1	0	1	0	1

Bits 0:1, 2:3, 4:5, 6:7 – CnTSEL CCPn Timer Selection bits

Value	Description
11	CCPn is based off Timer7 in Capture/Compare mode and Timer8 in PWM mode
10	CCPn is based off Timer5 in Capture/Compare mode and Timer6 in PWM mode
01	CCPn is based off Timer3 in Capture/Compare mode and Timer4 in PWM mode
00	CCPn is based off Timer1 in Capture/Compare mode and Timer2 in PWM mode

4. Appendix A: Revision History

Doc Rev.	Date	Comments
E	03/2021	Added silicon revisions 2.1.4, 2.1.5, 2.5.2, 2.6.3, 2.8.1 and 2.9.1. Data Sheet Clarifications: Added Module 3.2 (Pin Diagrams), Module 3.2 (Electrical Specifications), Module 3.3 (Analog-to-Digital Converter) and Module 3.4 (Capture/Compare/PWM (CCP) Module).
D	05/2018	Added Module 7: Electrical Specifications (FVR) and Module 8: Timer0. Data Sheet Clarifications: Added Module 1 (Core Features).
C	03/2017	Added silicone module 6: Electrical Specifications for LF Devices Only. Other minor corrections.
B	12/2016	Silicon Errata Issues: Removed section 1.2 Computation Overflow Bit; Added new sections 1.2 ADCRC Oscillator Operation in Sleep and 1.3 ADC Conversion with FVR to Module 1 Analog-to-Digital Converter (ADC).
A	09/2016	Initial release of this document.

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